Message

From: Olsen, Marian [Olsen.Marian@epa.gov]

Sent: 6/11/2019 1:26:18 PM

To: Phillips, Linda [Phillips.Linda@epa.gov]

CC: Haklar, James [Haklar.James@epa.gov]; Filipowicz, Urszula [Filipowicz.Urszula@epa.gov]

Subject: Comments on PCB Estimation tool

Attachments: Technical Review Form-PCB Exp Est Tool V2-MOlsen.docx

Hi Linda,

Thank you for the opportunity to review the PCB Estimation Tool. Attached are my comments. The signed form will be sent tomorrow when I return to the office.

In general, my comments are geared towards providing additional information to help the user.

Please let me know if you have any questions, or would like to discuss further.

Thanks.

Marian